

General description

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a ultra-small and flat lead SOD523 plastic package designed to protect one signal line from the damage caused by ESD and other transients.

Features and benefits

- Ultra Low Capacitance 0.3 pF(Typ)
- Reverse stand-off voltage: 5V Max
- Low leakage current: nA Level
- Response time is typically < 1 ns
- IEC61000-4-2 Level 4 ESD Protection

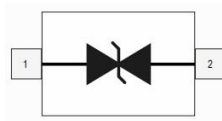
Application information

- High- speed data lines
- Smart phones
- Display Ports
- MDDI Ports
- USB Ports
- Digital Video Interface (DVI)
- PCI Express and Serial SATA Ports

Ordering information

Device	Package	Marking	Packaging
SLESD5LL5.0C	SOD523	L5	3000/Tape & Reel

Schematic & Pin configuration

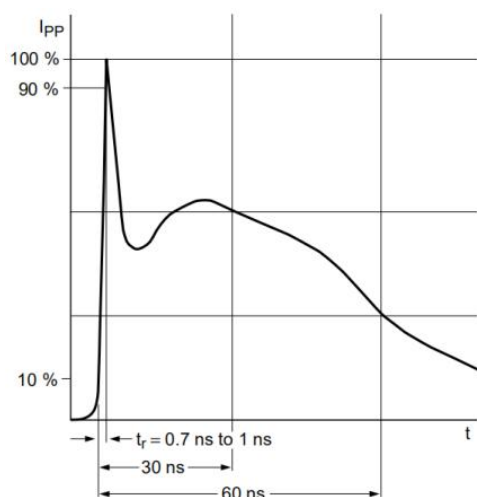
Simplified outline	Graphic symbol
	

Maximum Ratings

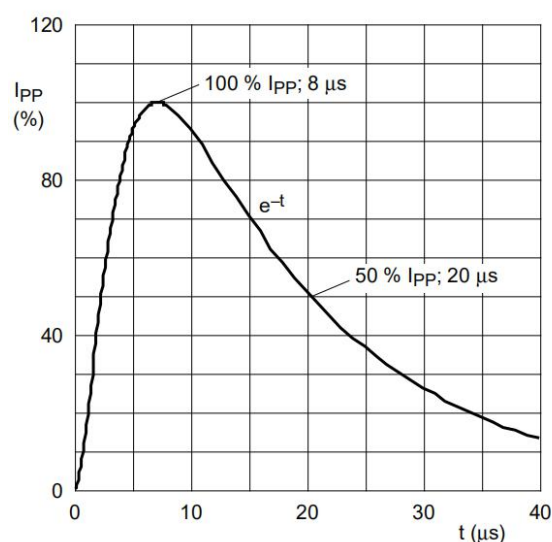
Parameter	Symbol	Value	Unit
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PPM}	80	W
Peak Pulse Current ($8/20\mu s$)	I_{PP}	4	A
ESD voltage IEC 61000-4-2 (air discharge)	V_{ESD}	20	kV
ESD voltage IEC 61000-4-2 (contact discharge)	V_{ESD}	15	kV
Maximum lead temperature for soldering during 10s	T_L	260	°C
Storage Temperature Range	T_{stg}	-55 to +150	°C
Operating Temperature Range	T_{OP}	-40 to +125	°C

Electrical Characteristics ($T_{OP} = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Condition
Reverse Working Voltage	V_{RWM}	--	--	5.0	V	
Breakdown Voltage	V_{BR}	6.2	--	8.5	V	$I_T=1mA$
Leakage Current I_{Leak}	I_R	--	--	100	nA	$V_{RWM}=5V$
Clamping Voltage	V_C	--	--	20.0	V	$I_{PP}=4A, T_p=8/20\mu s$
Junction Capacitance	C_J	--	0.3	0.40	pF	$V_R=0V, f=1MHz$



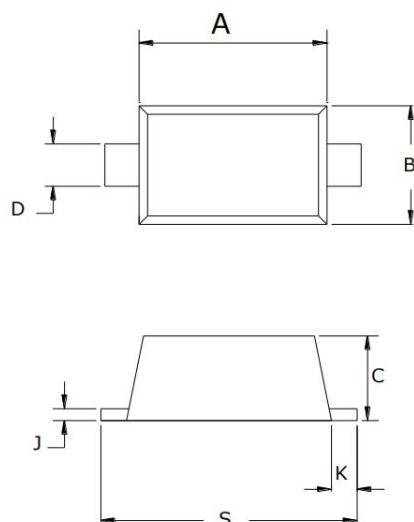
IEC61000-4-2 Waveform



IEC 61000-4-5 Waveform(8/20μs pulse)

Package Outline Dimensions

SOD523



SYMBOL	Dimensions In Millimet	
	MIN	MAX
A	1.10	1.30
B	0.70	0.90
C	0.50	0.70
D	0.25	0.35
J	0.07	0.20
K	0.15	0.25
S	1.50	1.70

Soldering Footprint (mm)

